

ABSTRACT OF THE DISCLOSURE

A conductive electroless plated powder includes core
5 particles and a nickel film formed by an electroless plating
process on the surface of each core particle, wherein crystal
grain boundaries are not recognized in the cross section in the
direction of the thickness of the nickel film when observed with
a scanning electron microscope at a magnification of up to
10 100,000. A method for making such a conductive electroless
plated powder is also disclosed.